

MOS FIELD EFFECT POWER TRANSISTOR

2SK1953



SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK1953 is N-channel MOS Field Effect Transistor designed for high voltage switching applications.

FEATURES

- Low On-state Resistance
 - $R_{\text{DS(on)}}$ = 5.0 Ω (Vgs = 10 V, Ip = 1 A)
- Low Ciss Ciss = 275 pF TYP.
- Built-in G-S Gate Protection Diode
- High Avalanche Capability Ratings

QUALITY GRADE

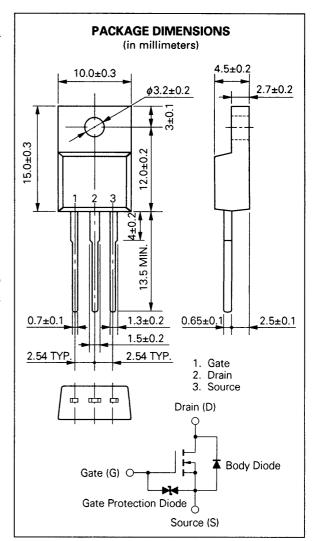
Standard

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

ABSOLUTE MAXIMUM RATINGS (Ta = 25 °C)

Drain to Source Voltage	Voss	600	٧
Gate to Source Voltage	Vgss	±30	V
Drain Current (DC)	ID(DC)	±2.0	Α
Drain Current (pulse)	D(pulse)#	±6.0	Α
Total Power Dissipation (Tc = 25 °C) Рт1	25	W
Total Power Dissipation (Ta = 25 °C)	Рт2	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	٥С
Single Avalanche Current	las**	3.0	Α
Single Avalanche Energy	Eas**	78	mJ

- * PW \leq 10 μ s, Duty Cycle \leq 1 %
- ** Starting Tch = 25 °C, Rg = 25 Ω , Vgs = 20 V \rightarrow 0





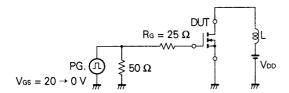


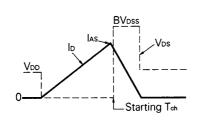
ELECTRICAL CHARACTERISTICS (Ta = 25 °C)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-state Resistance	Ros(on)		4.2	5.0	Ω	Vgs = 10 V, lp = 1 A
Gate to Source Cutoff Voltage	VGS(off)	2.0		4.0	V	Vps = 10 V, lp = 1 mA
Forward Transfer Admittance	y fs	0.5			s	Vos = 20 V, Io = 1 A
Drain Leakage Current	loss			100	μΑ	Vps = 600 V, Vgs = 0
Gate to Source Leakage Current	lgss			±10	μΑ	Vgs = ±25 V, Vps = 0
Input Capacitance	Ciss		275		pF	Vps = 10 V
Output Capacitance	Coss		68		рF	V _G s = 0
Reverse Transfer Capacitance	Cres		23		pF	f = 1 MHz
Turn-On Delay Time	td(on)		7		ns	$V_{GS} = 10 \text{ V}$ $V_{DD} = 150 \text{ V}$ $I_D = 1 \text{ A, R}_G = 10 \Omega$ $R_L = 150 \Omega$
Rise Time	tr		4		ns	
Turn-Off Delay Time	td(off)		37		ns	
Fall Time	tr		8		ns	
Total Gate Charge	QG		12		nC	V _G s = 10 V I _D = 2 A
Gate to Source Charge	Qgs		2.2		nC	
Gate to Drain Charge	Qgp		6.2		nC	V _{DD} = 450 V
Diode Forward Voltage	VF(S-D)		0.9		V	IF = 2 A, VGS = 0
Reverse Recovery Time	trr		340		ns	IF = 2 A
Reverse Recovery Charge	Qrr		1.1		μC	di/dt = 50 A/μs

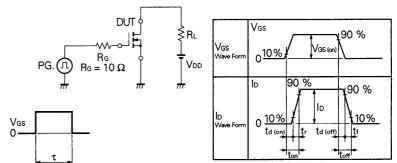
 $τ = 1 \mu s$ Duty Cycle $\le 1\%$

Test Circuit 1: Avalanche Capability

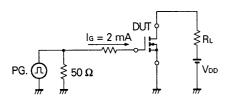




Test Circuit 2: Switching Time

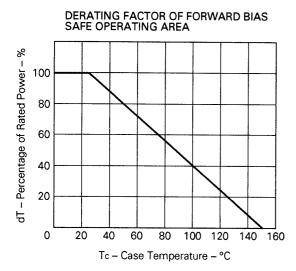


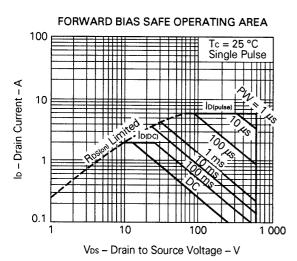
Test Circuit 3: Gate Charge

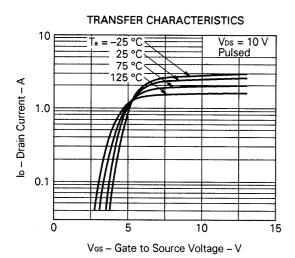


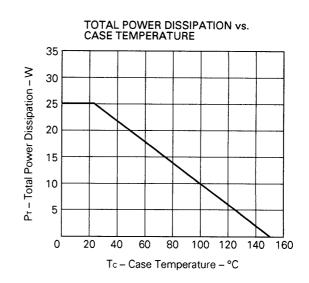


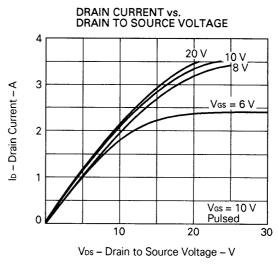
TYPICAL CHARACTERISTICS (Ta = 25 °C)

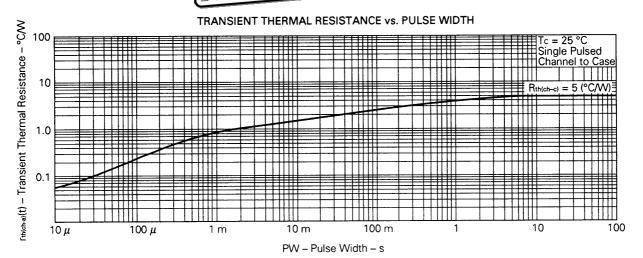


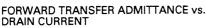


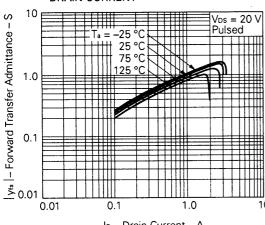




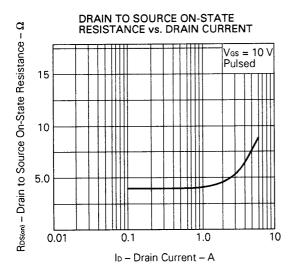




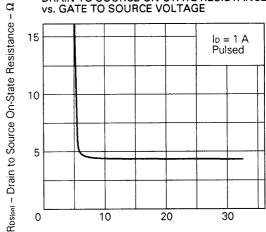




Ib - Drain Current - A



DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



V_{GS} – Gate to Source Voltage – V

GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE V_{GS(off)} – Gate to Source Cutoff Voltage – V 3.0 2.0

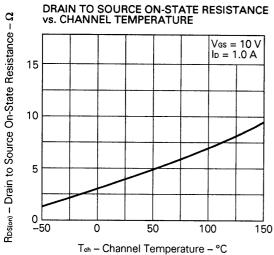
1.0

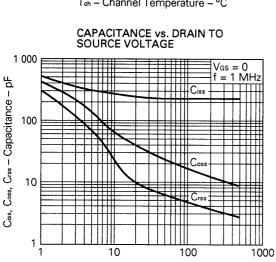
0 -50

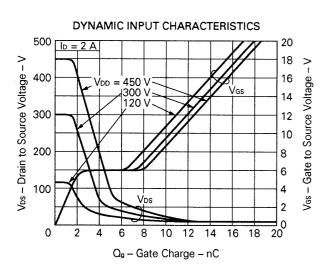
50 Tch - Channel Temperature - °C

100

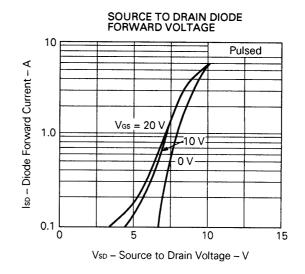
150

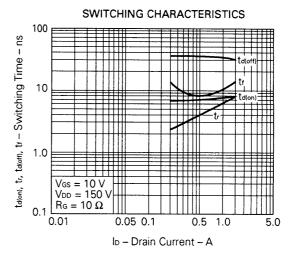


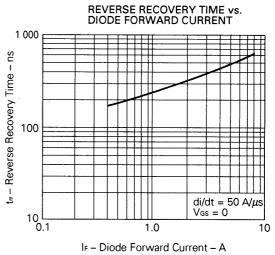




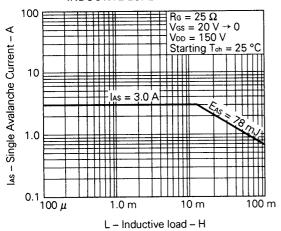
Vos - Drain to Source Voltage - V



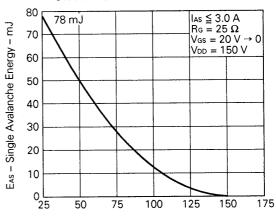




SINGLE AVALANCHE CURRENT vs. INDUCTIVE LOAD



SINGLE AVALANCHE ENERGY vs. STARTING CHANNEL TEMPERATURE



Starting T_{ch} – Starting Channel Temperature – °C



Reference

Application note name	No.
Safe operating area of Power MOS FET.	TEA-1034
Application circuit using Power MOS FET.	TEA-1035
Quality control of NEC semiconductors devices.	TEI-1202
Quality control guide of semiconductors devices.	MEI-1202
Assembly manual of semiconductors devices.	IEI-1207



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